

## 1.6X1.25mm BI-COLOR SMD CHIP LED LAMP



## **ATTENTION**

OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Part Number: APTB1612LQBDCGKC

Blue Green

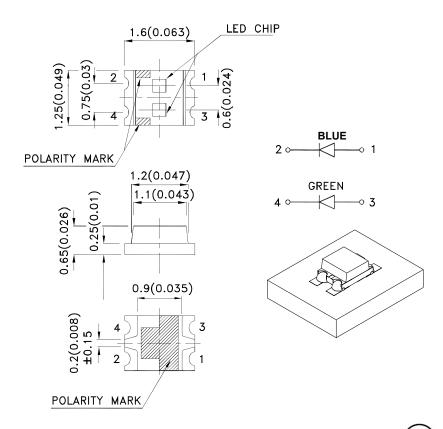
## **Features**

- 1.6mmx1.25mm SMD LED, 0.65mm thickness.
- Bi-color,low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- Low current IF=2mA operating.
- RoHS compliant.

## **Descriptions**

- The Blue source color devices are made with InGaN Light Emitting Diode.
- The Green source color devices are made with AlGalnP on GaAs substrate Light Emitting Diode.
- Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

## **Package Dimensions**



## Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.2(0.008") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

4. The device has a single mounting surface. The device must be mounted according to the specifications.

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 APPROVED: Wynec
 CHECKED: Allen Liu
 DRAWN: L.Q.Xie
 ERP: 1203015155

## **Selection Guide**

Part No.	Emitting Color (Material)	Lens Type	lv (mcd) [2] @ 2mA		Viewing Angle [1]
			Min.	Тур.	201/2
APTB1612LQBDCGKC	Blue (InGaN)	Water Clear	6	12	120°
	Green (AlGalnP)	Water Clear	1.2	3	

#### Notes

- 1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 2. Luminous intensity / luminous Flux: +/-15%.
- 3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

## Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Min.	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Blue Green		460 574		nm	IF=2mA
λD [1]	Dominant Wavelength	Blue Green		465 570		nm	IF=2mA
Δλ1/2	Spectral Line Half-width	Blue Green		25 20		nm	IF=2mA
С	Capacitance	Blue Green		100 15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Blue Green	2.2 1.5	2.65 1.9	3 2.1	V	IF=2mA
lr	Reverse Current	Blue Green			50 10	uA	V <sub>R</sub> = 5V

## Notes:

- 1. Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.
- 4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

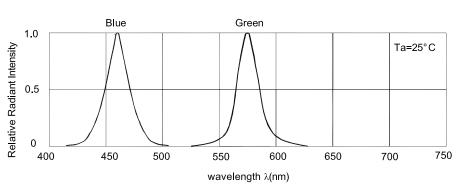
## Absolute Maximum Ratings at TA=25°C

Parameter	Blue	Green	Units		
Power dissipation	90	63	mW		
DC Forward Current	30	30	mA		
Peak Forward Current [1]	150	150	mA		
Electrostatic Discharge Threshold (HBM)	250	3000	V		
Reverse Voltage	5		V		
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

## Note:

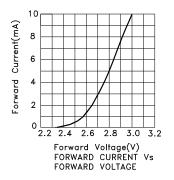
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

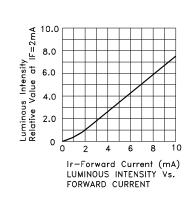
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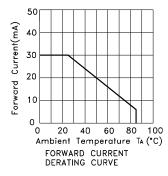


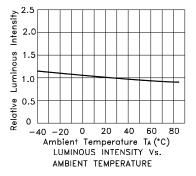
Relative Intensity Vs. Wavelength

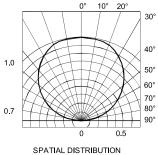
## APTB1612LQBDCGKC Blue





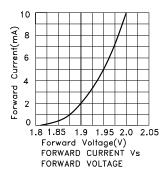


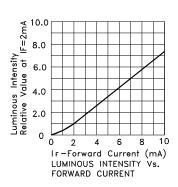


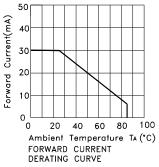


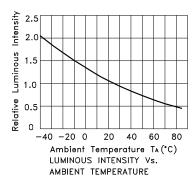
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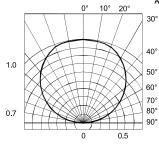
## Green











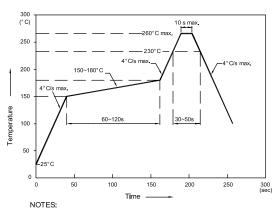
SPATIAL DISTRIBUTION

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## APTB1612LQBDCGKC

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



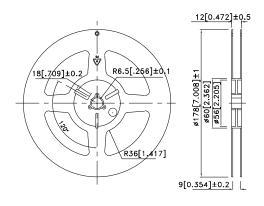
- 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed to high temperature
- to high temperature.
  3.Number of reflow process shall be 2 times or less.

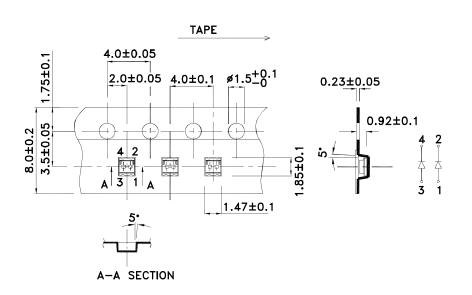
## Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

# 0.8

## Tape Dimensions (Units : mm)

## **Reel Dimension**

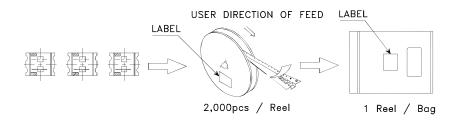


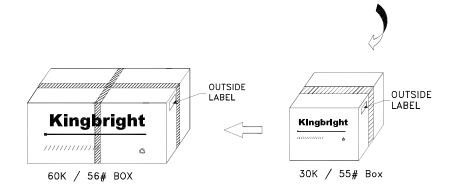


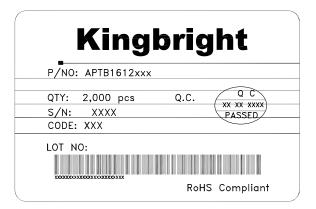
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## **PACKING & LABEL SPECIFICATIONS**

## **APTB1612LQBDCGKC**







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